### Board 2s SKYPER 32PRO R



### **SKYPER**<sup>®</sup>

### Adaptor board

### Board 2s SKYPER 32PRO R

### Preliminary Data

### Features

- Two output channels
- Failure management

### **Typical Applications\***

- Adaptor board for SKYPER 32 IGBT drivers in bridge circuits for industrial applications
- DC bus up to 1200V

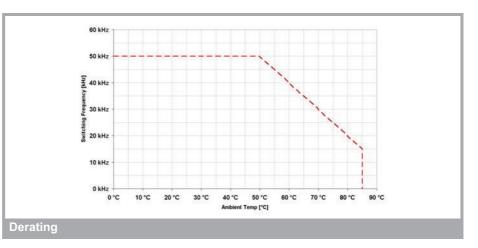
### Footnotes

All characteristics listed in the data sheet are guilty for the use with SKYPER 32 Please consider the derating of the ambient temperature

Please refer to the datasheet of SKYPER 32 for further information

Absolute	Maximum Ratings		
Symbol	Conditions	Values	Unit
			•
Vs	Supply voltage primary	16	V
lout <sub>PEAK</sub>	Output peak current	15	A
lout <sub>AVmax</sub>	Output average current	50	mA
f <sub>max</sub>	max. switching frequency	50	kHz
V <sub>CE</sub>	Collector emitter voltage sense across the IGBT	1700	V
V <sub>isol IO</sub>	Isolation test voltage input - output (AC, rms, 2s)	4000	V
VisoIPD	Partial discharge extinction voltage, rms, $Q_{PD} \leq 10pC$	1500	V
V <sub>isol12</sub>	Isolation test voltage output 1 - output 2 (AC, rms, 2s)	1500	V
R <sub>Gon min</sub>		1.5	Ω
R <sub>Goff min</sub>	Minimum rating for external R <sub>Goff</sub>	1.5	Ω
T <sub>op</sub>	Operating temperature	-25 85	°C
T <sub>stg</sub>	Storage temperature	-25 85	°C

#### Characteristics Symbol Conditions min. Unit typ. max. Vs Supply voltage primary side 14.4 15 15.6 V Vi 15/0 input signal voltage on / off V VIT+ Input treshold voltage HIGH 12.3 V VIT-Input threshold voltage (LOW) 4.6 V Turn on gate voltage output V V<sub>G(on)</sub> 15 $V_{G(off)}$ -7 Turn off gate voltage output V 1.2 Input-output turn-on propagation time μs t<sub>d(on)IO</sub> Input-output turn-off propagation time 1.2 t<sub>d(off)IO</sub> μs



This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

Adaptor board

# Adaptor Board 2s SKYPER<sup>®</sup> 32PRO R

**Technical Explanations** 

Revision 01

This Technical Explanation is valid for the f	ollowing parts:	
part number	type	date code (YYWW)
L6100241	Board 2s SKYPER <sup>®</sup> 32PRO R	≥ 1004
Related documents:		
title Technical Explanations SKYPER <sup>®</sup> 32PRC	$\overline{\mathcal{D}\mathcal{B}}$	

### Content

Application and Handling Instructions	3
Further application support	3
General Description	3
Dimensions	4
Component Placement Layout	
Signal IF_CMN_nHALT	
Setting Dead Time	
Setting Dynamic Short Circuit Protection	7
Collector Series Resistance	8
Adaptation Gate Resistors	8
Adaptation Decoupling Gate Resistors	8
Setting Soft Turn-Off	
Temperature Signal	9
Over Temperature Protection Circuit (OTP)	9
Mounting Notes	10
Schematics	
Parts List	14

#### Please note:

All values in this technical explanation are typical values. Typical values are the average values expected in large quantities and are provided for information purposes only. These values can and do vary in different applications. All operating parameters should be validated by user's technical experts for each application.

#### Application and Handling Instructions

- Please provide for static discharge protection during handling. As long as the hybrid driver is not completely assembled, the input terminals have to be short-circuited. Persons working with devices have to wear a grounded bracelet. Any synthetic floor coverings must not be statically chargeable. Even during transportation the input terminals have to be short-circuited using, for example, conductive rubber. Worktables have to be grounded. The same safety requirements apply to MOSFET- and IGBT-modules.
- Any parasitic inductances within the DC-link have to be minimised. Over-voltages may be absorbed by C- or RCDsnubber networks between main terminals for PLUS and MINUS of the power module.
- When first operating a newly developed circuit, SEMIKRON recommends to apply low collector voltage and load current in the beginning and to increase these values gradually, observing the turn-off behaviour of the free-wheeling diode and the turn-off voltage spikes generated across the IGBT. An oscillographic control will be necessary. Additionally, the case temperature of the module has to be monitored. When the circuit works correctly under rated operation conditions, short-circuit testing may be done, starting again with low collector voltage.
- It is important to feed any errors back to the control circuit and to switch off the device immediately in failure events.
  Repeated turn-on of the IGBT into a short circuit with a high frequency may destroy the device.
- The inputs of the hybrid driver are sensitive to over-voltage. Voltages higher than V<sub>S</sub> +0,3V or below -0,3V may destroy these inputs. Therefore, control signal over-voltages exceeding the above values have to be avoided.
- The connecting leads between hybrid driver and the power module should be as short as possible (max. 20cm), the driver leads should be twisted.

#### Further application support

Latest information is available at <u>http://www.semikron.com</u>. For design support please read the SEMIKRON Application Manual Power Modules available at <u>http://www.semikron.com</u>.

#### **General Description**

The Board 2s SKYPER<sup>®</sup> 32PRO R is an adaptor board for the IGBT module SEMiX<sup>®</sup> 2s (spring contact version). The board can be customized allowing adaptation and optimization to the used SEMiX<sup>®</sup> Module.

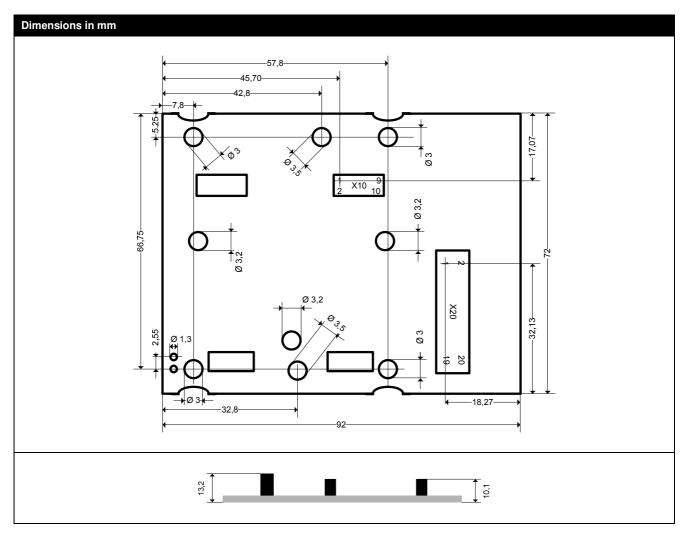
The switching characteristic of the IGBT can be influenced through user settings, e.g. changing turn-on and turn-off speed by variation of  $R_{Gon}$  and  $R_{Goff}$ . Furthermore, it is possible to adjust the monitoring level and blanking time for the DSCP (see Technical Explanations SKYPER<sup>®</sup> 32PRO R).

#### Please note:

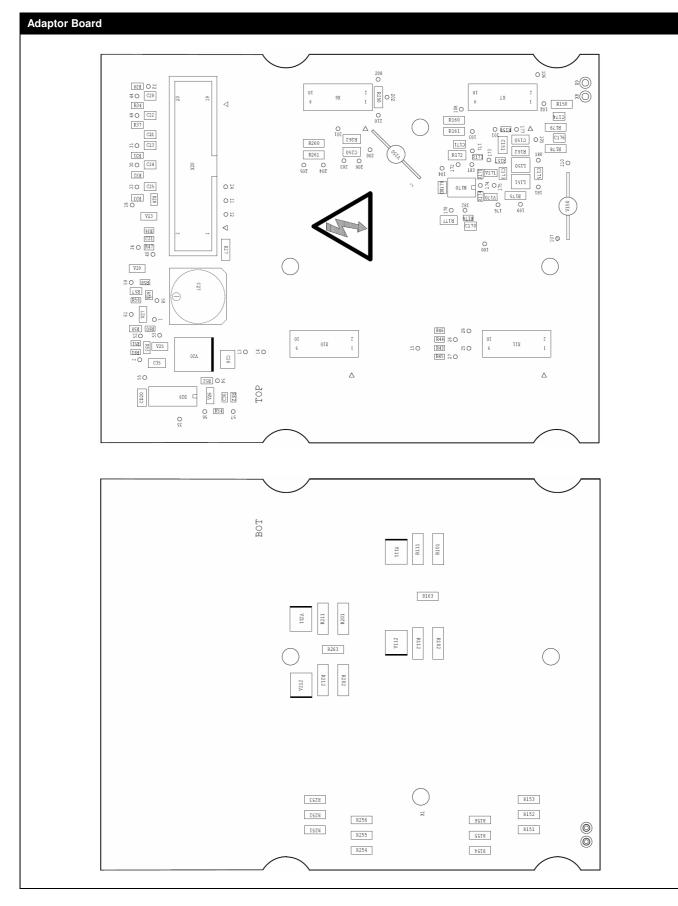
This technical explanation is based on the Technical Explanations for SKYPER® 32PRO R. Please read the Technical Explanations SKYPER® 32 PRO R before using the Adaptor Board.



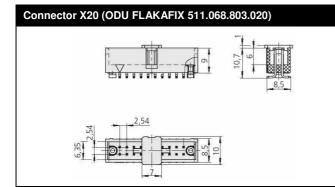
### Dimensions



### **Component Placement Layout**



### **PIN Array**



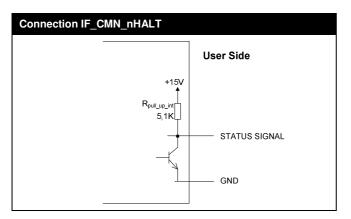
Product information of suitable female connectors and distributor contact information is available at e.g. http://www.harting.com (part number 09 18 520 6 813).

PIN	Signal	Function	Specification
X20:01	IF_PWR_15P	Drive power supply	Stabilised +15V ±4%
X20:02	IF_PWR_GND	GND for power supply	
X20:03	IF_PWR_15P	Drive power supply	Stabilised +15V ±4%
X20:04	IF_PWR_GND	GND for power supply	
X20:05	IF_PWR_15P	Drive power supply	Stabilised +15V ±4%
X20:06	IF_PWR_GND	GND for power supply	
X20:07	reserved		
X20:08	IF_PWR_GND	GND for power supply	
X20:09	IF_CMN_nHALT	Driver core status signal (bidirectional signal with dominant recessive behaviour)	Digital 15V logic; LOW (dominant) = driver disabled; HIGH (recessive) = ready to operate
X20:10	reserved		
X20:11	reserved		
X20:12	IF_CMN_GND	GND for signal IF_CMN_nHALT	
X20:13	reserved		
X20:14	reserved		
X20:15	IF_HB_TOP	Switching signal input (TOP switch)	Digital 15 V logic; 10 kOhm impedance; LOW = TOP switch off; HIGH = TOP switch on
X20:16	IF_HB_BOT	Switching signal input (BOTTOM switch)	Digital 15 V logic; 10 kOhm impedance; LOW = BOT switch off; HIGH = BOT switch on
X20:17	reserved		
X20:18	IF_HB_GND	GND for signals IF_HB_TOP & F_HB_BOT	
X20:19	reserved		
X20:20	reserved		

### Signal IF\_CMN\_nHALT

The Halt Logic Signals PRIM\_HALT\_IN and PRIM\_HALT\_OUT of the driver core are coupled to one bidirectional signal (IF\_CMN\_nHALT) with dominant recessive behaviour. IF\_CMN\_nHALT shows the driver core status. When IF\_CMN\_nHALT is HIGH (recessive), the driver core is ready to operate. When IF\_CMN\_nHALT is LOW (dominant), the driver core is disabled / not ready to operate because of e.g. detected failure or driver core system start.

A controller can hold with the IF\_CMN\_nHALT signal the driver core in a safe state (e.g. during a start up of a system or gathered failure signal of other hardware) or generate a coeval release of paralleled driver. Furthermore, paralleled drivers can send and receive IF\_CMN\_nHALT signals among each other by using a single-wire bus.



#### Setting Dead Time

Designation	Pattern Name	Setting
R43	0600	PRIM_CFG_TDT2_IN
(connected to GND)	0603	Factory setting: 0Ω
R44	0600	PRIM_CFG_SELECT_IN
(connected to GND)	0603	Factory setting: not equipped
R45	0000	PRIM_CFG_TDT3_IN
(connected to GND)	0603	Factory setting: 0Ω
R46	0000	PRIM_CFG_TDT1_IN
(connected to GND)	0603	Factory setting: not equipped

### **Setting Dynamic Short Circuit Protection**

Design	ation	Pattern Name	Setting	
R16	2	1206	R <sub>CE</sub> Factory setting: not equipped	TOP
C15	0	1206	C <sub>CE</sub> Factory setting: not equipped	TOP
R26	2	1206	R <sub>CE</sub> Factory setting: not equipped	BOT
C25	0	1206	C <sub>CE</sub> Factory setting: not equipped	BOT

### **Collector Series Resistance**

Designation	Pattern Name	Setting	
R150	MiniMELF	R <sub>vce</sub> * Factory setting: not equipped	TOP
R250	MiniMELF	R <sub>VCE</sub> * Factory setting: not equipped	BOT

### **Adaptation Gate Resistors**

Designation	Pattern Name	Sotting	
Designation	Fallen Name	Setting	
R151, R152, R153 (parallel connected)	MiniMELF	R <sub>Gon</sub> Factory setting: not equipped	TOP
R154, R155, R156 (parallel connected)	MiniMELF	R <sub>Goff</sub> Factory setting: not equipped	TOP
R251, R252, R253 (parallel connected)	MiniMELF	R <sub>Gon</sub> Factory setting: not equipped	BOT
R254, R255, R256 (parallel connected)	MiniMELF	R <sub>Goff</sub> Factory setting: not equipped	BOT

### **Adaptation Decoupling Gate Resistors**

For details to the decoupling gate resistors and recommended values, see Modules Explanations and Data Sheets SEMiX<sup>®</sup>.

Designation	Pattern Name	Setting	
Designation	i allem Name	ÿ	
R101	MELF	R <sub>G1</sub> Factory setting: not equipped	TOP
R102	MELF	R <sub>G2</sub> Factory setting: not equipped	TOP
R201	MELF	R <sub>G1</sub> Factory setting: not equipped	BOT
R202	MELF	R <sub>G2</sub> Factory setting: not equipped	BOT

### Setting Soft Turn-Off

Desirestian	Detterne Niene e	0.44%	
Designation	Pattern Name	Setting	
R160, R161 (parallel connected)	MiniMELF	R <sub>Goff_SC</sub> Factory setting: not equipped	TOP
R260, R261 (parallel connected)	MiniMELF	R <sub>Goff_SC</sub> Factory setting: not equipped	BOT

### **Temperature Signal**

The temperature sensor inside the SEMiX<sup>®</sup> module is directly connected to contacting points T1 and T2. For details to the temperature sensor, see Modules Explanations SEMiX<sup>®</sup>.

#### Safety Warnings:



The contacting points T1 and T2 are not electrical isolated. Due to high voltage that may be present at the contacting points T1 and T2, some care must be taken in order to avoid accident. There is no cover or potential isolation that protect the high voltage sections / wires from accidental human contact.

#### Please note:

If the contacting points T1 and T2 are used for adaptor of the temperature sensor, the Over Temperature Protection Ciruit must be disabled by taking out the resistors R175, R178 and R179.

### **Over Temperature Protection Circuit (OTP)**

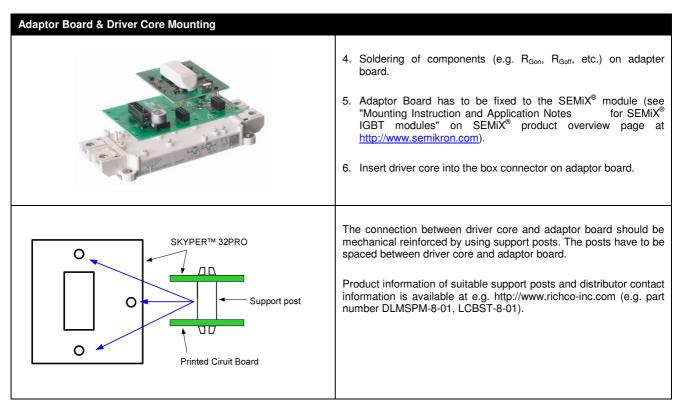
The external error input SEC\_TOP\_ERR\_IN on the secondary side (high potential) of the driver core is used for an over temperature protection circuit to place the gate driver into halt mode.

#### **Dimensioning OTP**

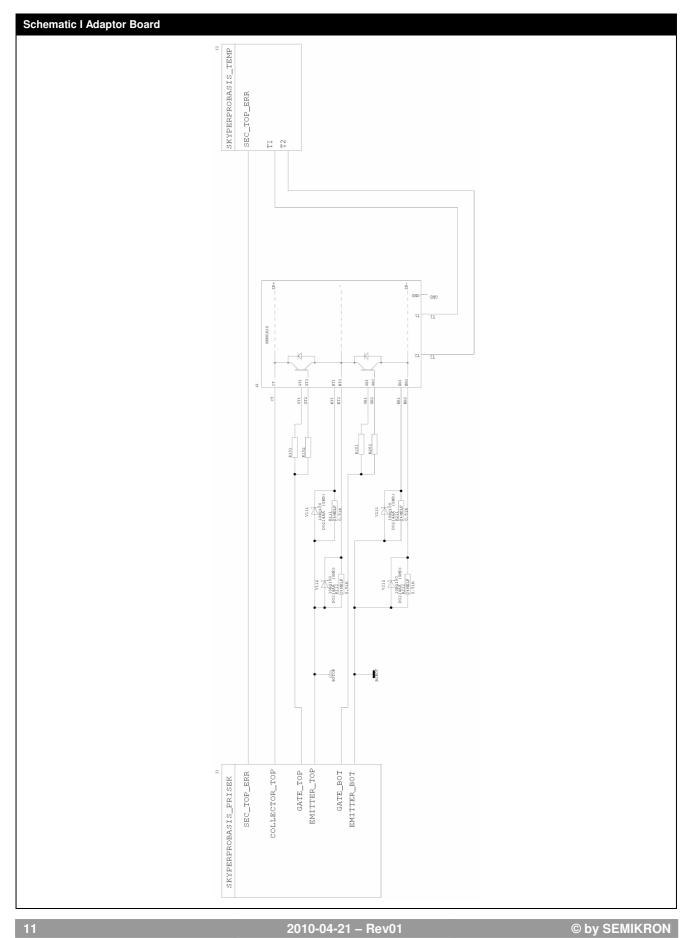
- 1. Define an over temperature trip level according to the application.
- Calculate the nominal ohmic resistance value of the temperature sensor at the defined trip level (see "Modules – Explanations - SEMiX<sup>®</sup>" on SEMiX<sup>®</sup> product overview page at <u>http://www.semikron.com</u>).
- 3. The trip level on the adapter board is set with R172 by using the calculated resistance value.
- Factory setting R172: not equipped
- If no resistor is used, a failure signal is generated.

### **Mounting Notes**

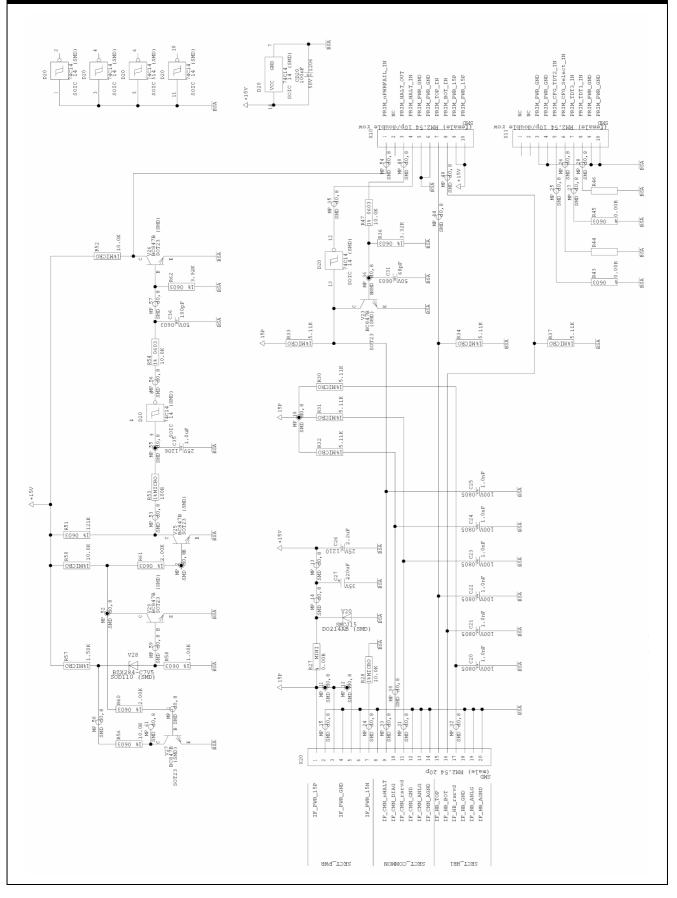
The electrical connections between adaptor board and SEMiX<sup>®</sup> are realised via spring contacts integrated in SEMiX<sup>®</sup> power modules and via landing pads on the bottom side of the adaptor board.



### Schematics



### Schematic II Adaptor Board



© by SEMIKRON

#### Schematic III Adaptor Board +15VTOP X9 TH 1.3/2.2 R157 90 #1 15.0K BSTO 174 R179 MINI 0.00R +15VTO MP 180 SMD 10,8 MP 172 SMD d0, 8 < I0 +15VTOP C173 R171 R178 MINI 0.00R MP 181 SMD 10,8 99 R177 7 1 1 3.01K X8 ) 1.3/2.2 N170 N17 MP 171 SMD 00,8 MP 183 1 MD d0, 8 LM2904 8 (SMD) 7 MP 182 SMD 00,8 LM2904 SOIC 8 (SMD) 5080 2171 25 100nF MP 178 R172 ΗĽ BSTO R176 090 1 30.1K C170 R174 1% 0603 30.1K MP 170 MD 00, 8 MP 174 R170 SMD 00,8 18 0603 30,1K 100nF K1. $\rightarrow$ BAY70W SOT323 +15VTOP · BAY70W SOT323 7 V171 V170 N170 BSTOP BSTOP (SMD) (SMD) LM2904 SOIC 8 (SMD) INIW R175 CN170 100nF 50V 08 5.628 IO \_\_\_\_\_ER SEC\_TOP\_ERR V150 MP 107 COLLECTOR\_TOP GATE\_TOP IO IO EMITTER\_BOT EMITTER\_TOP GATE\_BOT SBOT MP 210 V250 SMD 40, 8 203/205 B5T0P 13 10.00 10.0 MP\_100 SMD\_60,8 MP 200 SMD 40, 8 INIM %I 10.0K -15VTOP BSTOP -[]STOP SMD G0, 8 V C250 R250 MP 109 R253 R262 R254 R255 R256 R161 R251 R252 C150 MP 177 R158 SMD 40, 8 18 06 R154 R162 R150 R153 261 R151 R156 R152 R155 MP 103 MP 103 MP 103 MP 40, 8 MP 204 SMD G0, 8 MP 102 SMD G0, 8 MP 205 SMD 40, 8 MP 201 SMD 40, 8 MP 202 SMD 40, 8 <sup>8</sup> MP 208 SMD 40, 8 MP 105 SMD 60, 8 MP 203 SND 40, 8 MD 10 8 QMS wor elduob/q01 #2.SMS (elsmet) 582\_105\_V18\_016 582\_105\_V18\_017 582\_105\_M14\_01 582\_105\_M14\_01 582\_105\_P14\_01 582\_105\_P14\_01 582\_105\_P14\_01 582\_105\_P14\_01 582\_105\_P14\_01

### Parts List

### Parts List Adaptor Board

Count	Ref. Designator	Value	Pattern Name	Description
7	C170, C171, C173, C174, C175, C176, CN170	100nF	0805 (SMD)	Capacitor X7R
6	C20, C21, C22, C23, C24, C25	1nF	0805 (SMD)	Capacitor X7R
1	C26	2,2µF	1210 (SMD)	Capacitor X7R
1	C27	220uF/35V	SMD	Longlife-Elko
1	C31	68pF	0603 (SMD)	Capacitor NP0
2	C35, C151	1uF	1206 (SMD)	Capacitor X7R
1	C36	100pF	0603 (SMD)	Capacitor NP0
1	CD20	100nF	1206 (SMD)	Capacitor X7R
1	D20	74C14	SOIC 14 (SMD)	Logic-IC 74C
2	L150, L151	100uH	1210 (SMD)	Inductor
1	N170	LM2904	SOIC 8 (SMD)	Operational Amplifier
4	R111, R112, R201, R211, R212	0,51Ohm	Melf (SMD)	2%
2	R157, R171	15,0KOhm	0603 (SMD)	1%
1	R158	10,0Ohm	0603 (SMD)	1%
2	R163, R263	10,0KOhm	MiniMelf (SMD)	1%
3	R170, R174, R176	30,1KOhm	0603 (SMD)	1%
1	R175	5,62KOhm	MiniMelf (SMD)	1%
1	R177	3,01KOhm	1206 (SMD)	1%
3	R27, R178, R179	0,00Ohm	MiniMelf (SMD)	
3	R28, R50, R52	10,0KOhm	MicroMelf (SMD)	1%
6	R30, R31, R32, R33, R34, R37	5,11KOhm	MicroMelf (SMD)	1%
1	R36	3,32KOhm	0603 (SMD)	1%
2	R43, R45	0,00Ohm	0603 (SMD)	
3	R47, R54, R56	10,0KOhm	0603 (SMD)	1%
1	R51	121KOhm	0603 (SMD)	1%
1	R53	100Ohm	MicroMelf (SMD)	1%
1	R57	1,50KOhm	MicroMelf (SMD)	1%
1	R58	1,00KOhm	0603 (SMD)	1%
2	R60, R61	2,00KOhm	0603 (SMD)	1%
1	R62	3,92KOhm	0603 (SMD)	1%
4	V111, V112, V211, V212	10BQ100	SMB (SMD)	Diode Schottky
2	V150, V250	BY203/20S	SMD	High Voltage Diode
2	V170, V171	BAV70W	SOT323 (SMD)	Double Diode
1	V20	SMCJ15	DO214AB (SMD)	Suppressor Diode
5	V23, V25, V26, V27, V29	BC847B	SOT23 (SMD)	NPN-Transistor
1	V28	BZX284-C7V5	SOD110 (SMD)	Zener-Diode
1	X20	20p.	SMD	Connector
4	X6, X7, X10, X11	RM2,54 10p.	SMD	Box Connector

TP: Test Point

Box Connector: SUYIN 254100FA010G200ZU

#### DISCLAIMER

SEMIKRON reserves the right to make changes without further notice herein to improve reliability, function or design. Information furnished in this document is believed to be accurate and reliable. However, no representation or warranty is given and no liability is assumed with respect to the accuracy or use of such information. SEMIKRON does not assume any liability arising out of the application or use of any product or circuit described herein. Furthermore, this technical information may not be considered as an assurance of component characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability. This document supersedes and replaces all information previously supplied and may be supersede by updates without further notice.

SEMIKRON products are not authorized for use in life support appliances and systems without the express written approval by SEMIKRON.

### www.SEMIKRON.com